

PATENT APPLICATION

Applicant: Vitali Nesterenko et al.

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For: ISOSTATIC PRESSURE
ASSISTED WAFER BONDING
METHOD

Art Unit: 2823

Examiner: Stark, Jarrett J.

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

In response to the Final Office Action mailed March 5, 2009, and the Advisory Action mailed May 14, 2009, please consider the following remarks: